

CMOS LSI

SANYO

No. ※4854A

LC89517K**Built-in Subcode Interface CD-ROM/CD-I
Error Correction LSI****Preliminary****Overview**

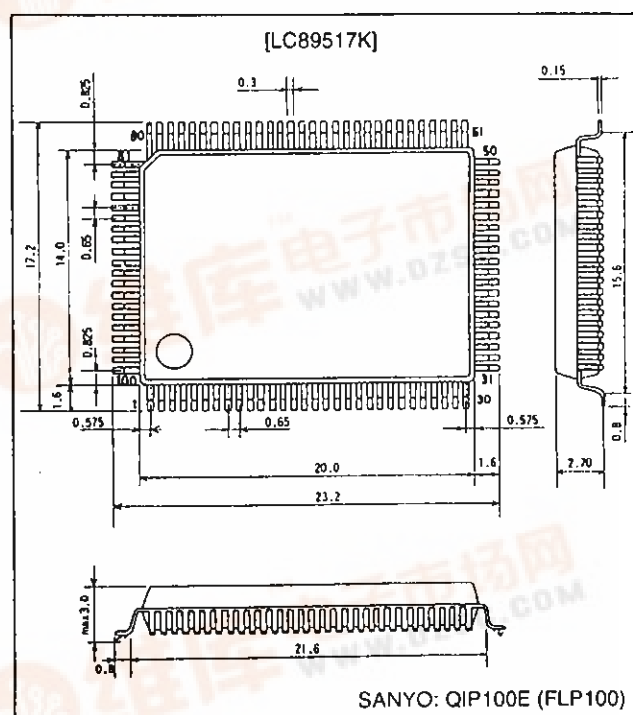
The LC89517K is a CD-ROM/CD-I error correction LSI that integrates the functions provided by the improved version of the LC89515 and a sub-code function in a single chip. The improved version of the LC89515 additionally supports double speed operation.

Features

- Support for double speed operation (selectable by setting an internal register) at an operating frequency of 16.9344 MHz
- Built-in 12-byte FIFO for transfers from the system microcontroller to the host computer
- Built-in 12-byte FIFO for transfers from the host computer to the system microcontroller
- Direct connection to the LC8955 (an ADPCM decoder LSI) and the LC8953 (a 68000 CPU peripheral interface LSI)
- Sub-code data can be written to buffer RAM simply by connecting the CD DSP sub-code pin. This allows the system microcontroller to read the sub-code values.
- The system microcontroller can access buffer RAM through the LC89517K.
- Pseudo-SRAM support (An interface circuit is built in.)

Package Dimensions

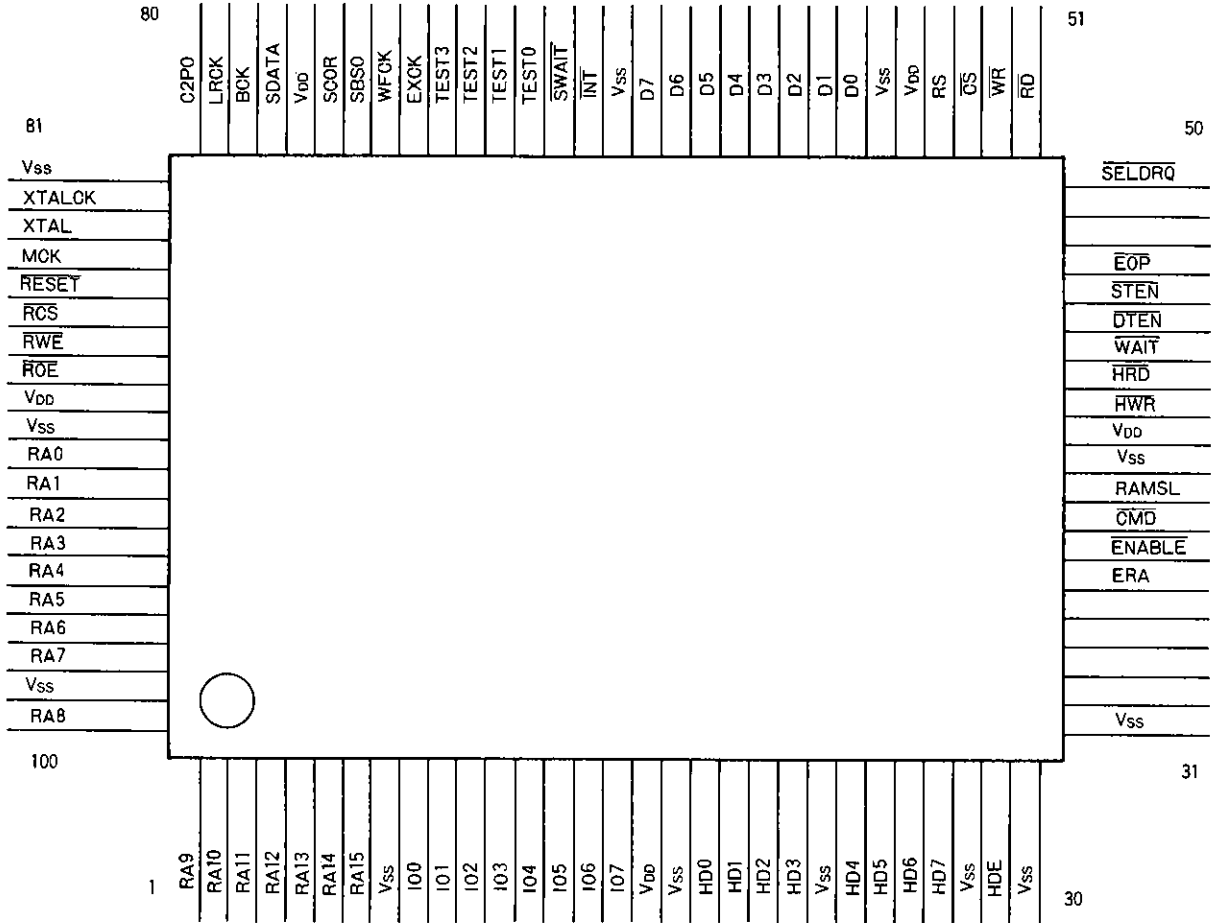
unit: mm

3151-QIP100E (FLP100)

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Pin Assignment



Top view

LC89517K

Pin Functions

Type: I: Input pin, O: Output pin, B: Bidirectional pin, P: Power supply pin, NC: Unconnected pin

Pin No.	Pin	Type	Function	
1	RA9	O	Data buffer RAM address signal outputs	
2	RA10	O		
3	RA11	O		
4	RA12	O		
5	RA13	O		
6	RA14	O		
7	RA15	O		
8	V _{SS}	P		
9	IO0	B	Data buffer RAM data signals	
10	IO1	B	These pins have built-in pull-up resistors.	
11	IO2	B		
12	IO3	B		
13	IO4	B		
14	IO5	B		
15	IO6	B		
16	IO7	B		
17	V _{DD}	P		
18	V _{SS}	P		
19	HD0	B	Host data signals These pins have built-in pull-up resistors.	
20	HD1	B		
21	HD2	B		
22	HD3	B		
23	V _{SS}	P		
24	HD4	B		
25	HD5	B		
26	HD6	B	Host data signals These pins have built-in pull-up resistors	
27	HD7	B		
28	V _{SS}	P		
29	HDE	O		Host erasure flag output (Connect to V _{DD} if unused.)
30	V _{SS}	P		
31	V _{SS}	P		
32		NC		
33		NC		
34		NC		
35		NC		
36	ERA	B	Data buffer RAM erasure flag signal (Connect to V _{SS} if unused.)	
37	ENABLE	I	Chip select signal input (from host computer)	
38	CMD	I	Host command/data selection signal	
39	RAMSL	I	DRAMSRAM switch	
40	V _{SS}	P		
41	V _{DD}	P		
42	HWR	I	Host data write signal input	
43	HRD	I	Host data read signal input	
44	WAIT	O	Wait signal output (to host). This pin can be switched to function as the DRQ signal.	
45	DTEN	O	Data enable signal output	
46	STEN	O	Status enable signal output	
47	EOP	O	End of process signal output. Used during DMA transfers.	
48		NC		
49		NC		
50	SELDRQ	I	Selects the mode for data transfers to the host.	

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Pin No.	Pin	Type	Function
51	\overline{RD}	I	Microcontroller data read signal input
52	\overline{WR}	I	Microcontroller data write signal input
53	\overline{CS}	I	Chip select signal input (from microcontroller)
54	RS	I	Register selection signal
55	V _{DD}	P	
56	V _{SS}	P	
57	D0	B	Microcontroller data signals. These pins have built-in pull-up resistors.
58	D1	B	
59	D2	B	
60	D3	B	
61	D4	B	
62	D5	B	
63	D6	B	
64	D7	B	
65	V _{SS}	P	
66	\overline{INT}	O	Interrupt request signal output (to the microcontroller) This pin is an open drain output with a built-in pull-up resistor.
67	\overline{SWAIT}	O	System microcontroller wait signal
68	TEST0	I	Test inputs. These pins should be tied low during normal operation.
69	TEST1	I	
70	TEST2	I	
71	TEST3	I	
72	EXCK	O	Sub-code I/O
73	WFCK	I	
74	SBSO	I	
75	SCOR	I	
76	V _{DD}	P	
77	SDATA	I	Serial data input
78	BCK	I	Serial data input clock
79	LRCK	I	44.1 kHz strobe signal input
80	C2PO	I	C2 pointer input
81	V _{SS}	P	
82	XTALCK	I	Crystal oscillator input
83	XTAL	O	Crystal oscillator output
84	MCK	O	Outputs the XTALCK input signal divided by 2.
85	\overline{RESET}	I	Chip select signal input
86	RCS	O	RAM chip select
87	RWE	O	RAM data write signal
88	ROE	O	RAM data read signal
89	V _{DD}	P	
90	V _{SS}	P	
91	RA0	O	Data buffer RAM address signal outputs
92	RA1	O	
93	RA2	O	
94	RA3	O	
95	RA4	O	
96	RA5	O	
97	RA6	O	
98	RA7	O	
99	V _{SS}	P	
100	RA8	O	Data buffer RAM address signal output

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Specifications

Absolute Maximum Ratings at $V_{SS} = 0$ V

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{DD} max	$T_a = 25^\circ\text{C}$	-0.3 to +7.0	V
I/O voltage	V_I, V_O	$T_a = 25^\circ\text{C}$	-0.3 to $V_{DD} + 0.3$	V
Allowable power dissipation	P_d max	$T_a \leq 70^\circ\text{C}$	350	mW
Operating temperature	T_{opr}		-30 to +70	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to +125	$^\circ\text{C}$
Soldering temperature		10 seconds	260	$^\circ\text{C}$

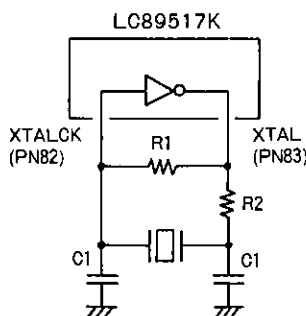
Allowable Operating Ranges at $T_a = -30$ to $+70^\circ\text{C}$, $V_{SS} = 0$ V

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V_{DD}		3.5	5.0	5.5	V
Input voltage range	V_{IN}		0		V_{DD}	V

DC Characteristics at $T_a = -30$ to $+70^\circ\text{C}$, $V_{SS} = 0$ V, $V_{DD} = 3.5$ to 5.5 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Input high level voltage	V_{IH1}	All input pins other than (1) and XTALCK	2.2			V
Input low level voltage	V_{IL1}				0.8	V
Input high level voltage	V_{IH2}	RESET, all bus pins (HRD, HWR, ENABLE, CMD, RD, CS, WR, WFCK, SBSO, SCOR) (1)	2.5			V
Input low level voltage	V_{IL2}				0.6	V
Output high level voltage	V_{OH1}	$I_{OH1} = -2$ mA: All output pins (including bus pins) other than (2) and XTALCK	2.4			V
Output low level voltage	V_{OL1}	$I_{OL1} = 2$ mA: All output pins (including bus pins) other than (2) and XTALCK			0.4	V
Output low level voltage	V_{OL2}	$I_{OL2} = 2$ mA: INT (open drain circuit with pull-up resistor) (2)			0.4	V
Output high level voltage	V_{OH3}	$I_{OH3} = -6$ mA: HD0 to HD7	2.4			V
Output low level voltage	V_{OL3}	$I_{OL3} = 6$ mA: HD0 to HD7			0.4	V
Input leakage current	I_L	$V_I = V_{SS}, V_{DD}$: All input pins	-25		+25	μA
Pull-up resistance	R_{UP}	All bus pins, INT	10	20	40	k Ω

Sample Recommended Oscillator Circuit



$R1 = 120$ k Ω
 $R2 = 47$ Ω
 $C1 = 30$ pF
 Crystal oscillator frequency = 16.9344 MHz